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DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION DOCKET NO. APSOL-002

As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Method For Forming A Wafer Level Chip Scale Package. And Package Formed Thereby

the specification of which (check one)		
X is attached hereto.		
was filed on		
v v v v Contal Mo		
and was amended on(if	applicable)	bove Identified specification including the claims, as
I hereby state that I have reviewed and amended by any amendment referred to	understand the contents of the at above.	bove identified specification in accordance with
I acknowledge the duty to disclose info Title 37, Code of Federal Regulations,	ormation which is material to the §1.56(a).	examination of this application in accordance with
I hereby claim foreign priority benefits inventor's certificate listed below and having a filing date before that of the s	under Title 35, United States Co	ode \$119 of any foreign application(s) for patent or breign application for patent or inventor's certificate laimed:
Prior Foreign Application(s)	•	Priority Claimed:
- 10100010 4	Singapore	10 December 2001
200107810-4 (Number)	(Country)	(Day/Month/Year Filed)
(Number)	(Country)	(Day/Month/Year Filed)
as the subject matter of each of the channer provided by the first paragrap information as defined in Title 37, Coapplication and the national or PCT is	sh of Title 35. United States Cod ode of Federal Regulations, §1.50 international filing date of this ap	any United States application(s) listed below and, insofar sclosed in the prior United States application in the e. §112, I acknowledge the duty to disclose material 6(a) which occurred between the filing date of the prior plication:
(A - Harrison Serial No.)	(Filing Date) (Statu	s) (patented, pending, abandoned)
I hereby declare that all statements melief are believed to be true; and fur the like so made are punishable by fix and that such willful false statements	nade herein of my own knowledge ther that these statements were no ne or imprisonment, or both, und s may jeopardize the validity of the	e are true and that all statements made on information and nade with the knowledge that willful false statements and der Section 1001 of Title 18 of the United States Code he application or any patent issued thereon.
POWER OF ATTORNEY: As a nar	ned inventor, I hereby appoint the	ne following attorney(s) and/or agent(s) to prosecute this fice connected therewith. (list name & registration no.)
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